

Part Number: XZCWD81FS

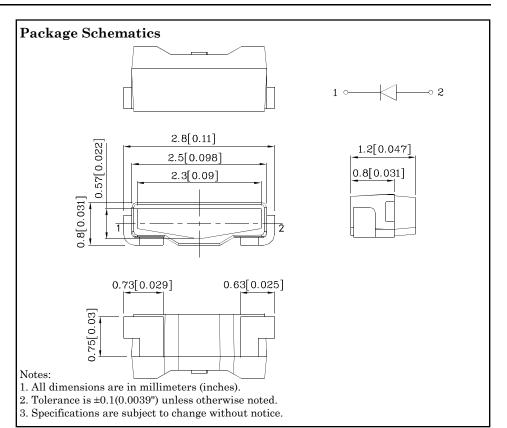
2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- \bullet RoHS compliant







Absolute Maximum Rating (TA=25°C)	CWD (InGaN)	Unit		
Reverse Voltage	VR	5	V	
Forward Current	$I_{\rm F}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	PD	120	mW	
Operating Temperature	$T_{\rm A}$	$\text{-}40 \sim \text{+}85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$		
Electrostatic Discharge Thres (HBM)	250	V		

Operating Characteristics (T _A =25°C)		CWD (InGaN)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V _F	3.3	V	
Forward Voltage (Max.) (I _F =20mA)	V _F	4	V	
Reverse Current (Max.) (V _R =5V)	I _R	50	uA	
Chromaticity Coordinates	x	0.31		
(Тур.)	У	0.31		
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	$_{\rm pF}$	

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (IF=20mA) mcd		Viewing Angle 20 1/2
				min.	typ.	
XZCWD81FS	White	InGaN	Water Clear	300*	497*	110°

*Luminous intensity value is in accordance with CIE127-2007 standards.

Feb 20,2014

XDSB3983 V3-Z Layout: Maggie L.



Handling Precautions

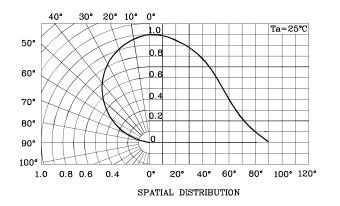
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

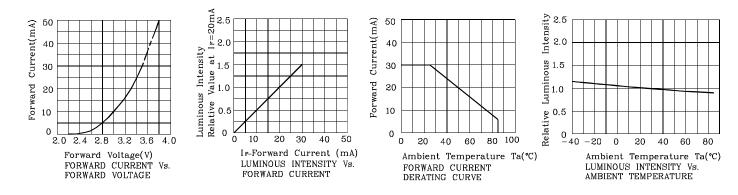


 $2. \ As \ silicone \ encapsulation \ is \ permeable \ to \ gases, \ some \ corrosive \ substances \ such \ as \ H_2S \ might \ corrode \ silver \ plating \ of \ leadframe. \ Special \ care \ should \ be \ taken \ if \ an \ LED \ with \ silicone \ encapsulation \ is \ to \ be \ used \ near \ substances.$





♦ CWD



LED is recommended for reflow soldering and soldering profile is shown below.

300 (°C) 10 s max 2097 250 4°C/s C/s max 200 150~180 4°C/s max 150 Temperature 30~50s 60~120s 100 50 0 150 0 50 100 200 250 300 (sec) Time Notes:

Reflow Soldering Profile for SMD Products (Pb-Free Components)

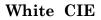
1. Maximum soldering temperature should not exceed 260°C

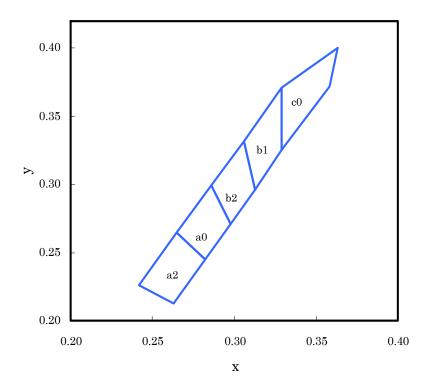
2. Recommended reflow temperature: 145°C-260°C 3. Do not put stress to the epoxy resin during

high temperatures conditions



XZCWD81FS





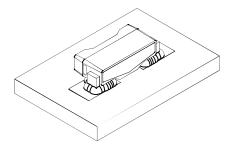
	X	У		х	У		x	У
	0.263	0.213	a0	0.282	0.245		0.298	0.271
a2	0.282	0.245		0.298	0.271	b2	0.313	0.296
az	0.265	0.265		0.286	0.299	02	0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

Notes:

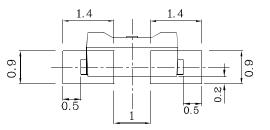
Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ± 0.01 .



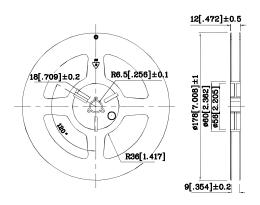
The device has a single mounting surface. The device must be mounted according to the specifications.



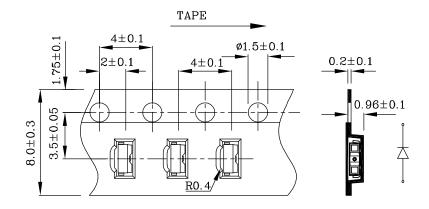
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or chromaticity),

the typical accuracy of the sorting process is as follows:

1. Measurement tolerance of the chromaticity coordinates is $\pm 0.01.$

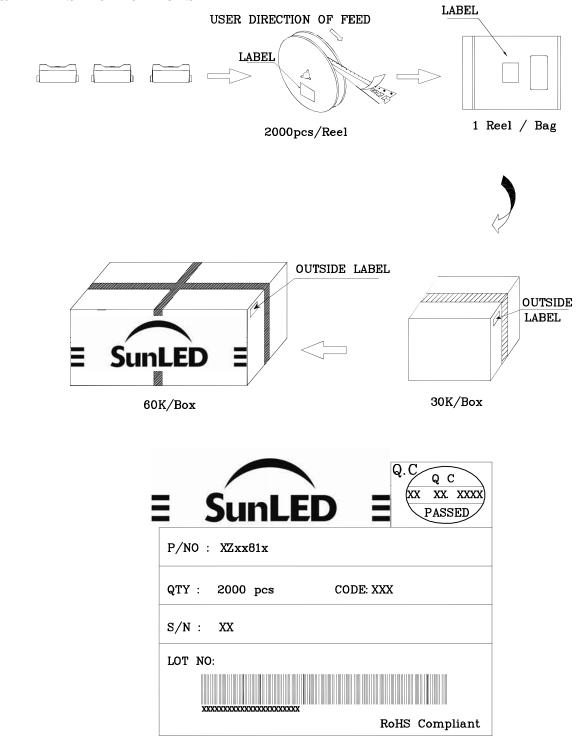
2. Luminous Intensity/ Luminous Flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications. 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$